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Details

Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	25MHz
Connectivity	EBI/EMI, SMBus (2-Wire/I ² C), SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, Temp Sensor, WDT
Number of I/O	64
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	4.25K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x8b, 8x10b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	https://www.e-xfl.com/product-detail/silicon-labs/c8051f022r

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C8051F020/1/2/3

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Figure 5.18. 12-Bit ADC0 Window Interrupt Example: Left Justified Single-Ended Data

Input Voltage (AD0 - AGND)	ADC Data Word		Input Voltage (AD0 - AGND)	ADC Data Word	
REF x (4095/4096)	0xFFFF	AD0WINT not affected	REF x (4095/4096)	0xFFFF	AD0WINT=1
	0x2010			0x2010	
REF x (512/4096)	0x2000	ADC0LTH:ADC0LTL	REF x (512/4096)	0x2000	ADC0GTH:ADC0GTL
	0x1FF0	AD0WINT=1		0x1FF0	AD0WINT not affected
	0x1010			0x1010	
REF x (256/4096)	0x1000	ADC0GTH:ADC0GTL	REF x (256/4096)	0x1000	ADC0LTH:ADC0LTL
	0x0FF0	AD0WINT not affected		0x0FF0	AD0WINT=1
0	0x0000		0	0x0000	

Given:
AMX0SL = 0x00, AMX0CF = 0x00,
AD0LJST = '1',
ADC0LTH:ADC0LTL = 0x2000,
ADC0GTH:ADC0GTL = 0x1000.
An ADC0 End of Conversion will cause an ADC0
Window Compare Interrupt (AD0WINT = '1') if
the resulting ADC0 Data Word is < 0x2000 and
> 0x1000.

Given:
AMX0SL = 0x00, AMX0CF = 0x00,
AD0LJST = '1'
ADC0LTH:ADC0LTL = 0x1000,
ADC0GTH:ADC0GTL = 0x2000.
An ADC0 End of Conversion will cause an ADC0
Window Compare Interrupt (AD0WINT = '1') if
the resulting ADC0 Data Word is < 0x1000 or
> 0x2000.

Table 5.1. 12-Bit ADC0 Electrical Characteristics (C8051F020/1)

VDD = 3.0V, AV+ = 3.0V, VREF = 2.40V (REFBE=0), PGA Gain = 1, -40°C to +85°C unless otherwise specified

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
DC ACCURACY					
Resolution		12			bits
Integral Nonlinearity				±1	LSB
Differential Nonlinearity	Guaranteed Monotonic			±1	LSB
Offset Error			-3±1		LSB
Full Scale Error	Differential mode		-7±3		LSB
Offset Temperature Coefficient			±0.25		ppm/°C
DYNAMIC PERFORMANCE (10 kHz sine-wave input, 0 to 1 dB below Full Scale, 100 ksps)					
Signal-to-Noise Plus Distortion		66			dB
Total Harmonic Distortion	Up to the 5 th harmonic		-75		dB
Spurious-Free Dynamic Range			80		dB
CONVERSION RATE					
SAR Clock Frequency				2.5	MHz
Conversion Time in SAR Clocks		16			clocks
Track/Hold Acquisition Time		1.5			µs
Throughput Rate				100	ksps
ANALOG INPUTS					
Input Voltage Range	Single-ended operation	0		VREF	V
*Common-mode Voltage Range	Differential operation	AGND		AV+	V
Input Capacitance			10		pF
TEMPERATURE SENSOR					
Nonlinearity		-1.0		+1.0	°C
Absolute Accuracy			±3		°C
Gain	PGA Gain = 1		2.86		mV/°C
Offset	PGA Gain = 1, Temp = 0°C		0.776		V
POWER SPECIFICATIONS					
Power Supply Current (AV+ supplied to ADC)	Operating Mode, 100 ksps		450	900	µA
Power Supply Rejection			±0.3		mV/V

Figure 6.16. 10-Bit ADC0 Window Interrupt Example: Right Justified Single-Ended Data

Input Voltage (AD0 - AGND)	ADC Data Word		Input Voltage (AD0 - AGND)	ADC Data Word	
REF x (1023/1024)	0x03FF	ADWINT not affected	REF x (1023/1024)	0x03FF	ADWINT=1
	0x0201			0x0201	
REF x (512/1024)	0x0200	ADC0LTH:ADC0LTL	REF x (512/1024)	0x0200	ADC0GTH:ADC0GTL
	0x01FF	ADWINT=1		0x01FF	ADWINT not affected
	0x0101			0x0101	
REF x (256/1024)	0x0100	ADC0GTH:ADC0GTL	REF x (256/1024)	0x0100	ADC0LTH:ADC0LTL
	0x00FF	ADWINT not affected		0x00FF	ADWINT=1
0	0x0000		0	0x0000	

Given:
 AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
 ADC0LTH:ADC0LTL = 0x0200,
 ADC0GTH:ADC0GTL = 0x0100.
 An ADC End of Conversion will cause an ADC
 Window Compare Interrupt (ADWINT=1) if the
 resulting ADC Data Word is < 0x0200 and
 > 0x0100.

Given:
 AMX0SL = 0x00, AMX0CF = 0x00, ADLJST = 0,
 ADC0LTH:ADC0LTL = 0x0100,
 ADC0GTH:ADC0GTL = 0x0200.
 An ADC End of Conversion will cause an ADC
 Window Compare Interrupt (ADWINT=1) if the
 resulting ADC Data Word is > 0x0200 or < 0x0100.

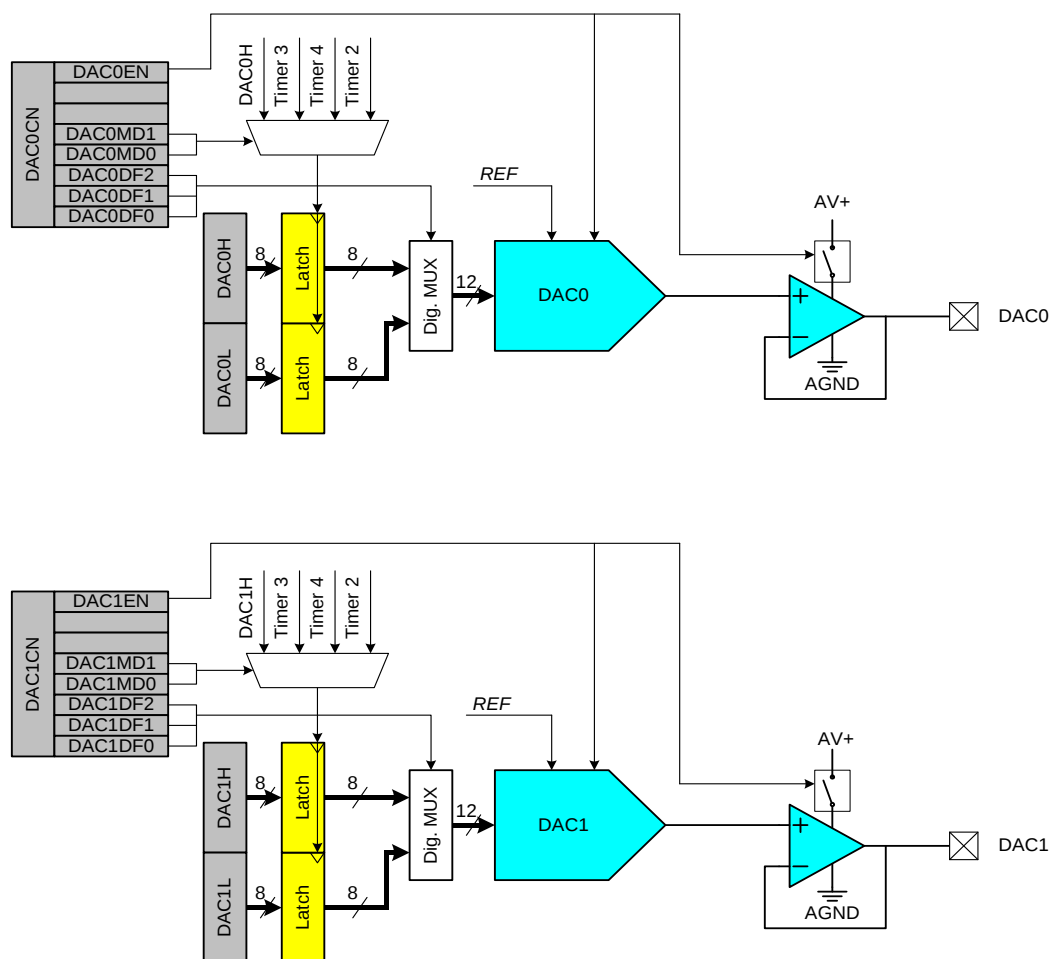
8. DACS, 12-BIT VOLTAGE MODE

Each C8051F020/1/2/3 device includes two on-chip 12-bit voltage-mode Digital-to-Analog Converters (DACs). Each DAC has an output swing of 0V to (VREF-1LSB) for a corresponding input code range of 0x000 to 0xFFF. The DACs may be enabled/disabled via their corresponding control registers, DAC0CN and DAC1CN. While disabled, the DAC output is maintained in a high-impedance state, and the DAC supply current falls to 1 μ A or less. The voltage reference for each DAC is supplied at the VREFD pin (C8051F020/2 devices) or the VREF pin (C8051F021/3 devices). Note that the VREF pin on C8051F021/3 devices may be driven by the internal voltage reference or an external source. If the internal voltage reference is used it must be enabled in order for the DAC outputs to be valid. See **Section “9. VOLTAGE REFERENCE (C8051F020/2)” on page 91** or **Section “10. VOLTAGE REFERENCE (C8051F021/3)” on page 93** for more information on configuring the voltage reference for the DACs.

8.1. DAC Output Scheduling

Each DAC features a flexible output update mechanism which allows for seamless full-scale changes and supports jitter-free updates for waveform generation. The following examples are written in terms of DAC0, but DAC1 operation is identical. Note that reads from DAC0L return pre-latch data, meaning the value read is the same as the last value written to this register, not the value at the DAC0L latch. Reads from DAC0H always return the value at the DAC0H latch.

Figure 8.1. DAC Functional Block Diagram



8.1.1. Update Output On-Demand

In its default mode ($\text{DAC0CN}[4:3] = '00'$) the DAC0 output is updated “on-demand” on a write to the high-byte of the DAC0 data register (DAC0H). It’s important to note that writes to DAC0L are held, and have no effect on the DAC0 output until a write to DAC0H takes place. If writing a full 12-bit word to the DAC data registers, the 12-bit data word is written to the low byte (DAC0L) and high byte (DAC0H) data registers. Data is latched into DAC0 after a write to the corresponding DAC0H register, **so the write sequence should be DAC0L followed by DAC0H** if the full 12-bit resolution is required. The DAC can be used in 8-bit mode by initializing DAC0L to the desired value (typically 0x00), and writing data to only DAC0H (also see [Section 8.2](#) for information on formatting the 12-bit DAC data word within the 16-bit SFR space).

8.1.2. Update Output Based on Timer Overflow

Similar to the ADC operation, in which an ADC conversion can be initiated by a timer overflow independently of the processor, the DAC outputs can use a Timer overflow to schedule an output update event. This feature is useful in systems where the DAC is used to generate a waveform of a defined sampling rate by eliminating the effects of variable interrupt latency and instruction execution on the timing of the DAC output. When the DAC0MD bits ($\text{DAC0CN}[4:3]$) are set to ‘01’, ‘10’, or ‘11’, writes to both DAC data registers (DAC0L and DAC0H) are held until an associated Timer overflow event (Timer 3, Timer 4, or Timer 2, respectively) occurs, at which time the DAC0H:DAC0L contents are copied to the DAC input latches allowing the DAC output to change to the new value.

8.2. DAC Output Scaling/Justification

In some instances, input data should be shifted prior to a DAC0 write operation to properly justify data within the DAC input registers. This action would typically require one or more load and shift operations, adding software overhead and slowing DAC throughput. To alleviate this problem, the data-formatting feature provides a means for the user to program the orientation of the DAC0 data word within data registers DAC0H and DAC0L. The three DAC0DF bits ($\text{DAC0CN}[2:0]$) allow the user to specify one of five data word orientations as shown in the DAC0CN register definition.

DAC1 is functionally the same as DAC0 described above. The electrical specifications for both DAC0 and DAC1 are given in Table 8.1.

Notes

12.3. Interrupt Handler

The CIP-51 includes an extended interrupt system supporting a total of 22 interrupt sources with two priority levels. The allocation of interrupt sources between on-chip peripherals and external inputs pins varies according to the specific version of the device. Each interrupt source has one or more associated interrupt-pending flag(s) located in an SFR. When a peripheral or external source meets a valid interrupt condition, the associated interrupt-pending flag is set to logic 1.

If interrupts are enabled for the source, an interrupt request is generated when the interrupt-pending flag is set. As soon as execution of the current instruction is complete, the CPU generates an LCALL to a predetermined address to begin execution of an interrupt service routine (ISR). Each ISR must end with an RETI instruction, which returns program execution to the next instruction that would have been executed if the interrupt request had not occurred. If interrupts are not enabled, the interrupt-pending flag is ignored by the hardware and program execution continues as normal. (The interrupt-pending flag is set to logic 1 regardless of the interrupt's enable/disable state.)

Each interrupt source can be individually enabled or disabled through the use of an associated interrupt enable bit in an SFR (IE-EIE2). However, interrupts must first be globally enabled by setting the EA bit (IE.7) to logic 1 before the individual interrupt enables are recognized. Setting the EA bit to logic 0 disables all interrupt sources regardless of the individual interrupt-enable settings.

Some interrupt-pending flags are automatically cleared by the hardware when the CPU vectors to the ISR. However, most are not cleared by the hardware and must be cleared by software before returning from the ISR. If an interrupt-pending flag remains set after the CPU completes the return-from-interrupt (RETI) instruction, a new interrupt request will be generated immediately and the CPU will re-enter the ISR after the completion of the next instruction.

12.3.1. MCU Interrupt Sources and Vectors

The MCUs support 22 interrupt sources. Software can simulate an interrupt event by setting any interrupt-pending flag to logic 1. If interrupts are enabled for the flag, an interrupt request will be generated and the CPU will vector to the ISR address associated with the interrupt-pending flag. MCU interrupt sources, associated vector addresses, priority order and control bits are summarized in Table 12.4. Refer to the datasheet section associated with a particular on-chip peripheral for information regarding valid interrupt conditions for the peripheral and the behavior of its interrupt-pending flag(s).

12.3.2. External Interrupts

Two of the external interrupt sources (/INT0 and /INT1) are configurable as active-low level-sensitive or active-low edge-sensitive inputs depending on the setting of bits IT0 (TCON.0) and IT1 (TCON.2). IE0 (TCON.1) and IE1 (TCON.3) serve as the interrupt-pending flag for the /INT0 and /INT1 external interrupts, respectively. If an /INT0 or /INT1 external interrupt is configured as edge-sensitive, the corresponding interrupt-pending flag is automatically cleared by the hardware when the CPU vectors to the ISR. When configured as level sensitive, the interrupt-pending flag follows the state of the external interrupt's input pin. The external interrupt source must hold the input active until the interrupt request is recognized. It must then deactivate the interrupt request before execution of the ISR completes or another interrupt request will be generated.

The remaining 2 external interrupts (External Interrupts 6-7) are edge-sensitive inputs configurable as active-low or active-high. The interrupt-pending flags and configuration bits for these interrupts are in the Port 3 Interrupt Flag Register shown in **Figure “17.19 P3IF: Port3 Interrupt Flag Register” on page 177**.

Figure 12.13. EIP1: Extended Interrupt Priority 1

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
PCP1R	PCP1F	PCP0R	PCP0F	PPCA0	PWADC0	PSMB0	PSPI0	00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xF6
Bit7:	PCP1R: Comparator1 (CP1) Rising Interrupt Priority Control. This bit sets the priority of the CP1 interrupt. 0: CP1 rising interrupt set to low priority level. 1: CP1 rising interrupt set to high priority level.							
Bit6:	PCP1F: Comparator1 (CP1) Falling Interrupt Priority Control. This bit sets the priority of the CP1 interrupt. 0: CP1 falling interrupt set to low priority level. 1: CP1 falling interrupt set to high priority level.							
Bit5:	PCP0R: Comparator0 (CP0) Rising Interrupt Priority Control. This bit sets the priority of the CP0 interrupt. 0: CP0 rising interrupt set to low priority level. 1: CP0 rising interrupt set to high priority level.							
Bit4:	PCP0F: Comparator0 (CP0) Falling Interrupt Priority Control. This bit sets the priority of the CP0 interrupt. 0: CP0 falling interrupt set to low priority level. 1: CP0 falling interrupt set to high priority level.							
Bit3:	PPCA0: Programmable Counter Array (PCA0) Interrupt Priority Control. This bit sets the priority of the PCA0 interrupt. 0: PCA0 interrupt set to low priority level. 1: PCA0 interrupt set to high priority level.							
Bit2:	PWADC0: ADC0 Window Comparator Interrupt Priority Control. This bit sets the priority of the ADC0 Window interrupt. 0: ADC0 Window interrupt set to low priority level. 1: ADC0 Window interrupt set to high priority level.							
Bit1:	PSMB0: System Management Bus (SMBus0) Interrupt Priority Control. This bit sets the priority of the SMBus0 interrupt. 0: SMBus interrupt set to low priority level. 1: SMBus interrupt set to high priority level.							
Bit0:	PSPI0: Serial Peripheral Interface (SPI0) Interrupt Priority Control. This bit sets the priority of the SPI0 interrupt. 0: SPI0 interrupt set to low priority level. 1: SPI0 interrupt set to high priority level.							

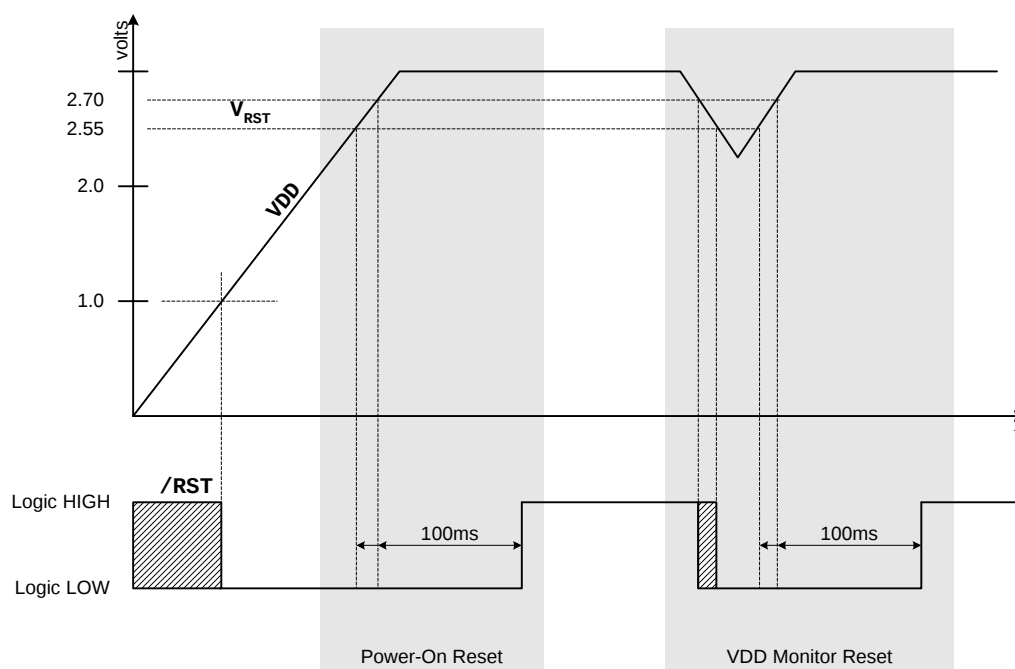
13.1. Power-on Reset

The C8051F020/1/2/3 family incorporates a power supply monitor that holds the MCU in the reset state until VDD rises above the V_{RST} level during power-up. See Figure 13.2 for timing diagram, and refer to Table 13.1 for the Electrical Characteristics of the power supply monitor circuit. The $\overline{RST}$ pin is asserted low until the end of the 100 ms VDD Monitor timeout in order to allow the VDD supply to stabilize.

On exit from a power-on reset, the PORSF flag (RSTSRC.1) is set by hardware to logic 1. All of the other reset flags in the RSTSRC Register are indeterminate. PORSF is cleared by all other resets. Since all resets cause program execution to begin at the same location (0x0000), software can read the PORSF flag to determine if a power-up was the cause of reset. The contents of internal data memory should be assumed to be undefined after a power-on reset.

The VDD monitor function is enabled by tying the MONEN pin directly to VDD. This is the recommended configuration for the MONEN pin.

Figure 13.2. Reset Timing



13.2. Power-fail Reset

When a power-down transition or power irregularity causes VDD to drop below V_{RST} , the power supply monitor will drive the $\overline{RST}$ pin low and return the CIP-51 to the reset state. When VDD returns to a level above V_{RST} , the CIP-51 will leave the reset state in the same manner as that for the power-on reset (see Figure 13.2). Note that even though internal data memory contents are not altered by the power-fail reset, it is impossible to determine if VDD dropped below the level required for data retention. If the PORSF flag is set to logic 1, the data may no longer be valid.

Figure 13.4. RSTSRC: Reset Source Register

R	R/W	R/W	R/W	R	R	R/W	R	Reset Value
-	CNVRSEF	CORSEF	SWRSEF	WDTRSF	MCDRSF	PORSF	PINRSF	Variable
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address: 0xEF

(Note: Do not use read-modify-write operations on this register.)

Bit7: Reserved.

Bit6: CNVRSEF: Convert Start Reset Source Enable and Flag
Write: 0: CNVSTR is not a reset source.
1: CNVSTR is a reset source (active low).
Read: 0: Source of prior reset was not CNVSTR.
1: Source of prior reset was CNVSTR.

Bit5: CORSEF: Comparator0 Reset Enable and Flag
Write: 0: Comparator0 is not a reset source.
1: Comparator0 is a reset source (active low).
Read: 0: Source of prior reset was not Comparator0.
1: Source of prior reset was Comparator0.

Bit4: SWRSF: Software Reset Force and Flag
Write: 0: No Effect.
1: Forces an internal reset. /RST pin is not affected.
Read: 0: Prior reset source was not a write to the SWRSF bit.
1: Prior reset source was a write to the SWRSF bit.

Bit3: WDTRSF: Watchdog Timer Reset Flag
0: Source of prior reset was not WDT timeout.
1: Source of prior reset was WDT timeout.

Bit2: MCDRSF: Missing Clock Detector Flag
0: Source of prior reset was not Missing Clock Detector timeout.
1: Source of prior reset was Missing Clock Detector timeout.

Bit1: PORSF: Power-On Reset Force and Flag
Write: 0: No effect.
1: Forces a Power-On Reset. /RST is driven low.
Read: 0: Source of prior reset was not POR.
1: Source of prior reset was POR.

Bit0: PINRSF: HW Pin Reset Flag
0: Source of prior reset was not /RST pin.
1: Source of prior reset was /RST pin.

Notes

Figure 17.17. P3: Port3 Data Register

R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
P3.7	P3.6	P3.5	P3.4	P3.3	P3.2	P3.1	P3.0	11111111
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
						(bit addressable)		0xB0

Bits7-0: P3.[7:0]: Port3 Output Latch Bits.
 (Write - Output appears on I/O pins per XBR0, XBR1, XBR2, and XBR3 Registers)
 0: Logic Low Output.
 1: Logic High Output (open if corresponding P3MDOUT.n bit = 0).
 (Read - Regardless of XBR0, XBR1, XBR2, and XBR3 Register settings).
 0: P3.n pin is logic low.
 1: P3.n pin is logic high.

Note: P3.[7:0] can be driven by the External Data Memory Interface (as AD[7:0] in Multiplexed mode, or as D[7:0] in Non-multiplexed mode). See **Section “16. EXTERNAL DATA MEMORY INTERFACE AND ON-CHIP XRAM” on page 145** for more information about the External Memory Interface.

Figure 17.18. P3MDOUT: Port3 Output Mode Register

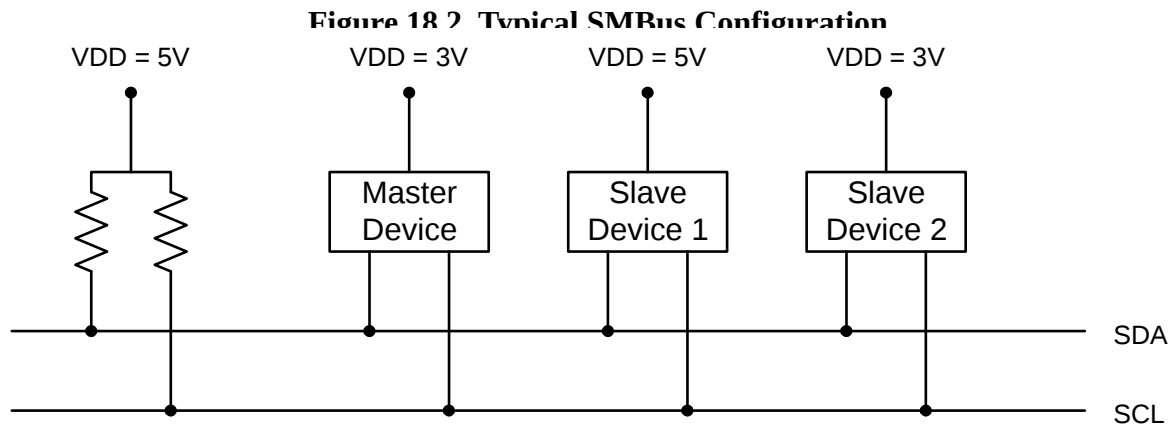
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	Reset Value
								00000000
Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	SFR Address:
								0xA7

Bits7-0: P3MDOUT.[7:0]: Port3 Output Mode Bits.
 0: Port Pin output mode is configured as Open-Drain.
 1: Port Pin output mode is configured as Push-Pull.

Note: SDA, SCL, and RX0 (when UART0 is in Mode 0) and RX1 (when UART1 is in Mode 0) are always configured as Open-Drain when they appear on Port pins.

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Figure 18.2 shows a typical SMBus configuration. The SMBus0 interface will work at any voltage between 3.0 V and 5.0 V and different devices on the bus may operate at different voltage levels. The bi-directional SCL (serial clock) and SDA (serial data) lines must be connected to a positive power supply voltage through a pull-up resistor or similar circuit. Every device connected to the bus must have an open-drain or open-collector output for both the SCL and SDA lines, so that both are pulled high when the bus is free. The maximum number of devices on the bus is limited only by the requirement that the rise and fall times on the bus will not exceed 300 ns and 1000 ns, respectively.



18.1. Supporting Documents

It is assumed the reader is familiar with or has access to the following supporting documents:

1. The I²C-bus and how to use it (including specifications), Philips Semiconductor.
2. The I²C-Bus Specification -- Version 2.0, Philips Semiconductor.
3. System Management Bus Specification -- Version 1.1, SBS Implementers Forum.

20.1.3. Mode 2: 9-Bit UART, Fixed Baud Rate

Mode 2 provides asynchronous, full-duplex communication using a total of eleven bits per data byte: a start bit, 8 data bits (LSB first), a programmable ninth data bit, and a stop bit. Mode 2 supports multiprocessor communications and hardware address recognition (see [Section “20.2. Multiprocessor Communications” on page 210](#)). On transmit, the ninth data bit is determined by the value in TB80 (SCON0.3). It can be assigned the value of the parity flag P in the PSW or used in multiprocessor communications. On receive, the ninth data bit goes into RB80 (SCON0.2) and the stop bit is ignored.

Data transmission begins when an instruction writes a data byte to the SBUF0 register. The TI0 Transmit Interrupt Flag (SCON0.1) is set at the end of the transmission (the beginning of the stop-bit time). Data reception can begin any time after the REN0 Receive Enable bit (SCON0.4) is set to logic 1. After the stop bit is received, the data byte will be loaded into the SBUF0 receive register if RI0 is logic 0 and one of the following requirements are met:

1. SM20 is logic 0
2. SM20 is logic 1, the received 9th bit is logic 1, and the received address matches the UART0 address as described in [Section 20.2](#).

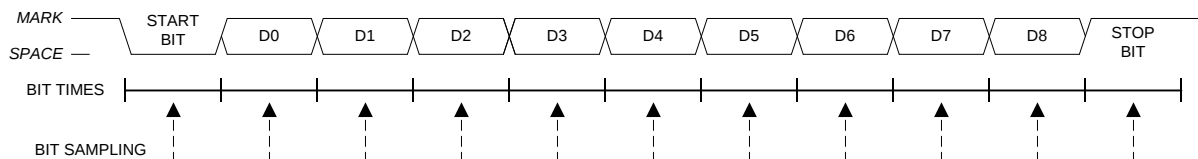
If the above conditions are satisfied, the eight bits of data are stored in SBUF0, the ninth bit is stored in RB80 and the RI0 flag is set. If these conditions are not met, SBUF0 and RB80 will not be loaded and the RI0 flag will not be set. An interrupt will occur if enabled when either TI0 or RI0 is set.

The baud rate in Mode 2 is either $\text{SYSCLK} / 32$ or $\text{SYSCLK} / 64$, depending on the value of the SMOD0 bit in register PCON.

Equation 20.3. Mode 2 Baud Rate

$$\text{BaudRate} = 2^{\text{SMOD0}} \times \left(\frac{\text{SYSCLK}}{64} \right)$$

Figure 20.5. UART Modes 2 and 3 Timing Diagram



21. UART1

UART1 is an enhanced serial port with frame error detection and address recognition hardware. UART1 may operate in full-duplex asynchronous or half-duplex synchronous modes, and multiprocessor communication is fully supported. Receive data is buffered in a holding register, allowing UART1 to start reception of a second incoming data byte before software has finished reading the previous data byte. A Receive Overrun bit indicates when new received data is latched into the receive buffer before the previous received byte is read.

UART1 is accessed via its associated SFRs, Serial Control (SCON1) and Serial Data Buffer (SBUF1). The single SBUF1 location provides access to both transmit and receive registers. Reads access the Receive register and writes access the Transmit register automatically.

UART1 may be operated in polled or interrupt mode. UART1 has two sources of interrupts: a Transmit Interrupt flag, TI1 (SCON1.1) set when transmission of a data byte is complete, and a Receive Interrupt flag, RI1 (SCON1.0) set when reception of a data byte is complete. UART1 interrupt flags are not cleared by hardware when the CPU vectors to the interrupt service routine; they must be cleared manually by software. This allows software to determine the cause of the UART1 interrupt (transmit complete or receive complete).

Figure 21.1. UART1 Block Diagram

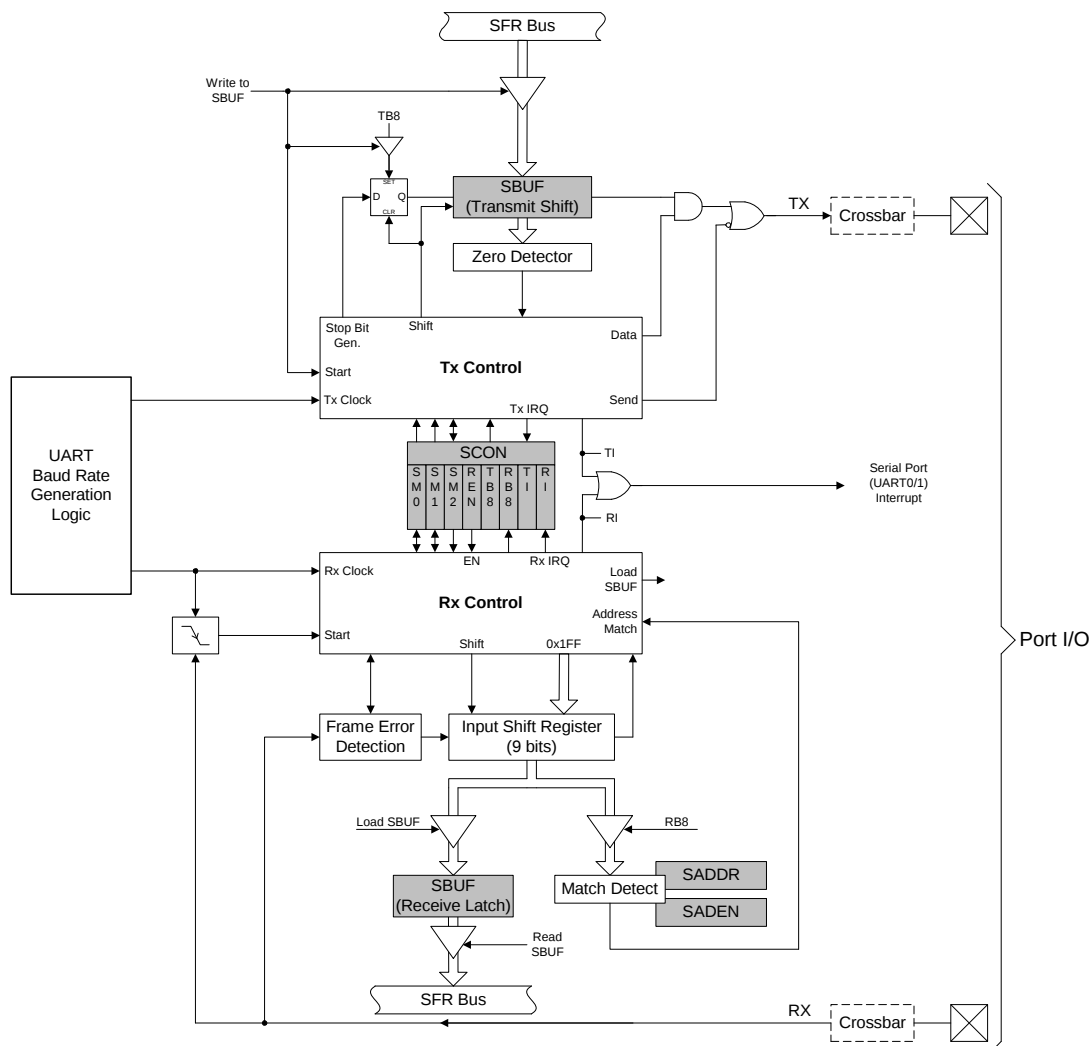


Table 21.2. Oscillator Frequencies for Standard Baud Rates

Oscillator frequency (MHz)	Divide Factor	Timer 1 Load Value*	Resulting Baud Rate (Hz)**
25.0	434	0xE5	57600 (57870)
25.0	868	0xCA	28800
24.576	320	0xEC	76800
24.576	848	0xCB	28800 (28921)
24.0	208	0XF3	115200 (115384)
24.0	833	0xCC	28800 (28846)
23.592	205	0xF3	115200 (113423)
23.592	819	0xCD	28800 (28911)
22.1184	192	0xF4	115200
22.1184	768	0xD0	28800
18.432	160	0xF6	115200
18.432	640	0xD8	28800
16.5888	144	0xF7	115200
16.5888	576	0xDC	28800
14.7456	128	0xF8	115200
14.7456	512	0xE0	28800
12.9024	112	0xF9	115200
12.9024	448	0xE4	28800
11.0592	96	0xFA	115200
11.0592	348	0xE8	28800
9.216	80	0xFB	115200
9.216	320	0xEC	28800
7.3728	64	0xFC	115200
7.3728	256	0xF0	28800
5.5296	48	0xFD	115200
5.5296	192	0xF4	28800
3.6864	32	0xFE	115200
3.6864	128	0xF8	28800
1.8432	16	0xFF	115200
1.8432	64	0xFC	28800

* Assumes SMOD1=1 and T1M=1.

** Numbers in parenthesis show the actual baud rate.